

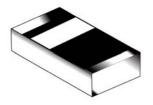
CHIP DIODE

Switching Diode

CD4148WSP

1:6

Switching Diode CD4148WSP



FEATURES

- Silicon epitaxial planar diode
- SMD chip pattern, available in various dimension included 1206 & 0603
- Leadfree and RoHS compliance components
- For small signal switching and operating ambient temperature less than 55°C and voltage withstand less than 60V; not suitable for AC switching input as rectified circuit and high reverse voltage location. CD4148WSN is suitable for those application

MECHANICAL CHARACTERISTICS

- Size: 0805
- Weight: approx. 6mg
- Marking: Cathode terminal

DIMENSIONS

Dimension/mm	0805
L	2.0±0.2
W	1.25±0.2
Т	0.85±0.1
С	0.45±0.2





THERMAL CHARACTERISTICS¹⁾

Parameter at T _{amb} =25°C ¹⁾	Symbol	Value	Unit
Forward Power Dissipation	D	200	mW
Power derating above 25°C	P _{tot}	1.6	mW/ °C
Junction Temperature	T _j	150	°C
Thermal Resistance Junction to Ambient air	R _{0JA}	375	°C/W
Operating& Storage Temperature range	T _{stq}	-55 to 150	°C

1) Valid provided that electrodes are kept at ambient temperature.



CHIP DIODE

2:6

Switching Diode

CD4148WSP

MAXIMUM RATING¹⁾

Parameter at T _{amb} =25°C ¹⁾	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V _{RRM}	75	V
Average rectified current sin half wave rectification with resistive load	$\mathrm{I}_{F(AV)}$	150	mA
Repetitive Peak Forward Current at T _{amb} =25°C	I _{FRM}	300	mA
Non-Repetitive Surge Forward Current at t<1s and T _i =25°C	I _{FSM}	500	mA
at t \leq 8.3ms and T _j =25°C		1000	mA

1) Valid provided that electrodes are kept at ambient temperature.

ELECTRICAL CHARACTERISTICS¹⁾

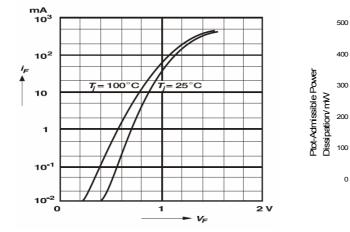
Parameter at T _{amb} =25°C ¹⁾	Symbol	Value	Unit
Forward Voltage at I_F =10mA	VF	1.0 _{MAX}	V
at I _F =100mA	VF	1.25 _{MAX}	V
Leakage Current at V _R =20V	т	0.025 _{MAX}	uA
Leakage Current at V _R =75V	I _R	5 _{MAX}	uA
Capacitance at $V_R=0V$, f=1MHz	C _{tot}	4 _{MAX}	pF
Reverse Recovery Time at $I_{\text{F}} = I_{\text{R}} = 10 \text{mA}, \text{R}_{\text{L}} = 100\Omega$	t _{rr}	4 _{MAX}	ns

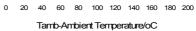
1) Valid provided that electrodes are kept at ambient temperature.

TYPICAL CHARACTERISTICS

Figure 1. Forward Characteristic

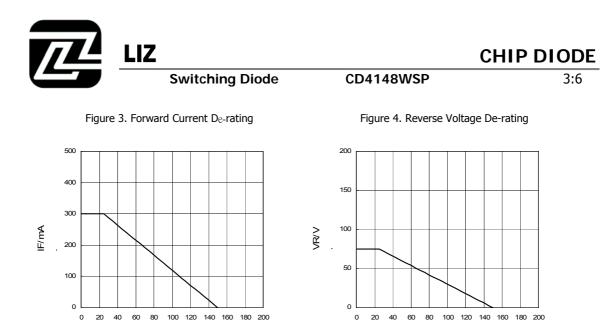






0

-www.lizgroup.com



Tamb-Ambient Temperature/oC

TEST CHARACTERISTICS

Tamb-Ambient Temperature/oC

Test Item	Test Condition	Requirement
Solderability	Sn bath at 245±5°C for 2±0.5s	>95% area tin covered
Resistance to Soldering Heat	Sn bath at 260±5°C for 10±2s	V _F ,V _R & I _R within spec; no mechanical damage
Humidity Steady State	At 85°C 85%RH for 168hrs	$V_{\text{F}} V_{\text{R}} \& I_{\text{R}}$ within spec
Continue Forward Operating Life	At 25°C $I_F = 1.1I_F$ for 1000hrs	V_F , V_R & I_R within spec
Thermal Shock	$-55 \pm 5^{\circ}$ C/5min to $150\pm 5^{\circ}$ C/5min for 10cycles	$V_F, V_R \& I_R$ within spec
Bending Strength	Bending up to 2mm for 1cycle	$V_F, V_R \& I_R$ within spec; no mechanical damage

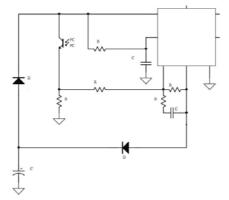


4:6

CD4148WSP

APPLICATIONS

- Function: suit for small signal switching application
- Typical Application circuit:

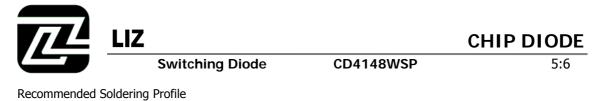


- Typical Product field: General application except high reverse voltage location
- Soldering Condition:

Soldering Condition & Caution

 Recommended Soldering Condition (Refer to IPC/JEDEC J-STD-020D 4-1&5.2) 	2)			
Recommended Profile Condition	Sn-Pb Soldering	Leadfree Soldering	Wave Soldering	
Ramp-up rate (from pre-heat stage)	<3°C/s	<3°C/s	∆T<150°C	
Dro hast Tomporature & Time	100-150 °C	150-200 °C	100-150 °C	
Pre-heat Temperature & Time	60-120s	60-120s	60-120s	
Coldening Townsonthing & Times	183 °C	217 °C	260±5°C	
Soldering Temperature & Time	60-150s	60-150s	5±2s	
Pools Tomporature	230±5°C	245±5°C	260±5°C	
Peak Temperature	<260°C	<260°C	200±5 C	
Time within 5°C of peak temperature	10-20s	20-30s	-	
Ramp-down rate	<6°C/s	<6°C/s	<6°C/s	
Time 25°C to peak temperature	<6min	<8min	-	
Manual Soldering: Approx. 350°C for 3s, avoid solder iron tip direct touch the components body				

-www.lizgroup.com



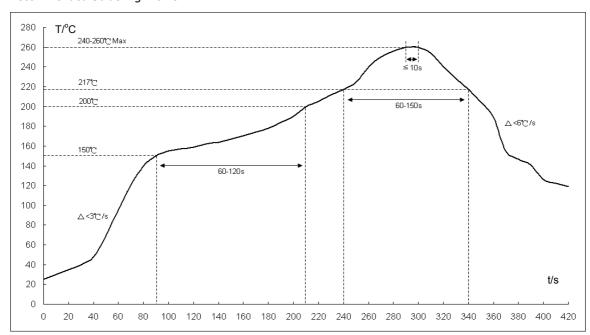
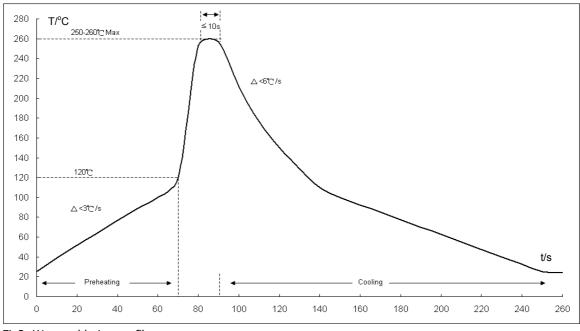
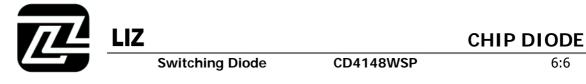


Fig1: Reflow soldering profile for lead-free solder (SnAgCu)

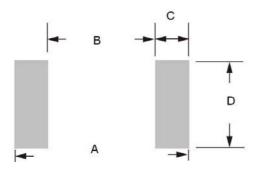




- *1. The recommended profiles are referring to IPC/JEDEC J-STD-020D & IEC-60068-2-58
- *2. Chip diodes are able to stand maximum soldering temperature up to 260°C max for 10s, and the soldering cycles with max 3 times, referring to IEC-60068-2-58



Recommended Soldering Footprint:



Reflow/Wave Soldering

Product Size	Dimension/ mm			
Product Size	А	В	С	D
0805	2.6-3.4	1.2	0.7-1.1	1.2-1.4

Storage Condition: Product termination solderability can degrade due to high temperature and humidity or chemical environment. Storage condition must be in an ambient temperature of <40°C and ambient humidity of <75%RH, and free from chemical.</p>

ENVIRONMENTAL CHARACTERISTICS

	Hazardous Substance or Element/ppm					
Product	Pb	Cd	Hg	Cr ⁶⁺	PBB	PBDE
	<1000	<100	<1000	<1000	<1000	<1000
	Halagan Cubatanaa/ anm					

Product	Halogen Substance/ ppm				
	F	Cl	Br	Ι	Total
	<900	<900	<900	<900	<1500

PACKING METHOD

Product	Quality/Reel	Reel Size	Таре
Troduct	5,000pcs	7″	Paper

DISCLAIMERS

These products are not designed for use in applications where any failure or malfunction may resulted in personal injury, death or severe property or environmental damage such as medical, military, aircraft, space or life support equipments.

-www.lizgroup.com

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Diodes - General Purpose, Power, Switching category:

Click to view products by LIZ manufacturer:

Other Similar products are found below :

MCL4151-TR3 MMBD3004S-13-F RD0306T-H RD0506LS-SB-1H RGP30G-E373 DSE010-TR-E BAQ333-TR BAQ335-TR BAQ33-GS18 BAS1602VH6327XT BAV17-TR BAV19-TR BAV301-TR BAW27-TAP HSC285TRF-E NSVBAV23CLT1G NTE525 1SS181-TP 1SS184-TP 1SS193,LF 1SS193-TP 1SS400CST2RA SBAV99LT3G SDAA13 LL4448-GS18 SHN2D02FUTW1T1G LS4150GS18 LS4151GS08 SMMBD7000LT3G FC903-TR-E 1N4449 1N4934-E3/73 1SS226-TP APT100DL60HJ RFUH20TB3S RGP30G-E354 RGP30M-E3/73 D291S45T MCL4151-TR BAS 16-02V H6327 BAS 21U E6327 BAS 28 E6327 BAS33-TAP BAS 70-02V H6327 BAV300-TR BAV303-TR3 BAW27-TR BAW56DWQ-7-F BAW56M3T5G BAW75-TAP